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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/762,901	01/22/2004	Joseph L. Pikulski	HRL/007-03	6163
759	90 05/16/2006		EXAMINER	
AAGAARD & BALZAN, LLP			JOHNSON, JONATHAN J	
Suite 105 674 County Square Drive			ART UNIT	PAPER NUMBER
Ventura, CA 9			1725	
		DATE MAILED: 05/16/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/762,901	PIKULSKI, JOSEP	H L.			
Office Action Summary	Examiner	Art Unit				
	Jonathan Johnson	1725	·			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence add	dress			
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA. - Extensions of time may be available under the provisions of 37 CFR 1.1: after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period varieties to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	 lely filed the mailing date of this co (35 U.S.C. § 133). 				
Status						
1)⊠ Responsive to communication(s) filed on <u>31 M</u>	arch 2006.					
,	action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.				
Disposition of Claims			-			
4) Claim(s) 1-44 is/are pending in the application.			•			
4a) Of the above claim(s) <u>22-44</u> is/are withdraw						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-21</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) <u>1-44</u> are subject to restriction and/or of	election requirement.					
Application Papers			÷			
9)☐ The specification is objected to by the Examine						
10) The drawing(s) filed on is/are: a) acc						
Applicant may not request that any objection to the			:D 4 404/4)			
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex						
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a))-(d) or (f).	•			
a) All b) Some * c) None of:	priority under ou o.e.e. g e(e)	, (5, 5. (.).				
1.☐ Certified copies of the priority document	s have been received.					
2. Certified copies of the priority document		on No				
3. Copies of the certified copies of the prio	rity documents have been receive	ed in this National	Stage			
application from the International Burea	· · · · · · · · · · · · · · · · · · ·					
* See the attached detailed Office action for a list of the certified copies not received.						
Attachment(s)	_					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Summary Paper No(s)/Mail D					
 Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date)-152)			
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DETAILED ACTION

Election/Restrictions

The examiner withdraws the species restriction and will examine claims 1-21.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-21 are rejected under 35 U.S.C. 102(e) as being anticipated by US 2004/0134976 (Keyser). Keyser teaches a solder matrix (paragraph 25); b) microparticles secured with the solder matrix (paragraph 25); and c) the microparticles being constructed so as to be capable of arranging during a solder bonding process so as to provide a substantially uniform separation between opposing soldered surfaces (paragraph 9 and 23); wherein the microparticles are embedded within the solder matrix (paragraph 25); wherein the microparticles are shaped so as to inhibit stacking while self arranging during a solder bonding process (paragraph 25); an amount of microparticles with respect to an amount of the solder matrix so as to inhibit stacking of the microparticles during a solder bonding process (paragraph 9 and 25); wherein the microparticles are shaped so as to inhibit stacking while self arranging during a solder bonding process (paragraph 9 and 25); wherein the microparticles are shaped so as to inhibit stacking while self arranging during a solder bonding process (paragraph 9 and 25); wherein the microparticles comprise microspheres

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(paragraph 25); wherein the microparticles comprise at least one of: (a) glass; (b) plastic; (c) elastomer; (d) metal; (e) semiconductor; (f) material capable of conducting electric current; or (g) dielectric material (paragraph 25); wherein the microparticles comprise generally regular particles; wherein the microparticles have a coefficient of expansion such that a combined coefficient of expansion of the microparticles and the solder matrix is in a range between the opposing soldered surfaces (paragraph 23); wherein the microparticles have a coefficient of expansion lower, higher or the same as a coefficient of expansion of the solder matrix (paragraph 23); wherein the microparticles are distributed substantially uniformly through the solder matrix (paragraphs 23-27 and figure 3); wherein the microparticles are embedded near an exterior surface of the solder matrix (figure 3, and paragraphs 23-27); wherein the microparticles are secured to an exterior surface of the solder matrix (figure 3, and paragraphs 23-27); wherein the plurality of microspheres comprises microspheres comprising at least one of: (a) glass; (b) plastic; (c) elastomer; (d) metal; (e) semiconductor; (f) material capable of conducting electric current; or (g) dielectric material. and b) a plurality of microspheres having a substantially similar diameter embedded within the solder matrix (paragraph 25 and figure 5, item 24).

Response to Arguments

Applicant's arguments with respect to claims 1-21 have been considered but are moot in view of the new ground(s) of rejection.

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Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jonathan Johnson whose telephone number is 571-272-1177. The examiner can normally be reached on M-Th 7:30 AM-5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Pat Ryan can be reached on 571-272-1292. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jonathan Johnson Primary Examiner Art Unit 1725